

#### Discription

The ESD0504F is a 5-channel ultra low capacitance rail clamp ESD protection diodes array. Each channel consists of a pair of ESD diodes that steer positive or negative ESD current to either the positive or negative rail.A zener diode is integrated in to the array between the positive and negative supply rails.In the typical applications, the negative rail pin (assigned as GND) is connected with system ground. The Positive ESD current is steered to the ground through an ESD diode and Zener diode and the positive ESD voltage is clamped

#### **FEATURES**

- ★ 5 channels of ESD protection;
- ★ Provides ESD protection to IEC61000-4-2 level 4
  - ±27kV air discharge

to the zener voltage.

- ±15kV contact discharge;
- ★ Low clamping voltage;
- ★ Low operating voltage;
- ★ Improved zener structure;
- ★ Optimized package for easy high speed data lines PCB layout;
- ★ RoHS compliant.
- ★ S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

#### **Ordering information**

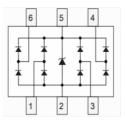
Product ID	Pack	Qty(PCS)
ESD0504F	SOT-363	3000

#### Absolute Ratings (T<sub>amb</sub>=25°C)

Characteristics	Symbol	Ratings	Unit
Peak Pulse Power(8/20µs)	P <sub>PP</sub>	55	W
Peak Pulse Current(8/20µs)	I <sub>PP</sub>	4	А
ESD per IEC 61000-4-2(Air)	$V_{ESD1}$	±20kV	kV
ESD per IEC 61000-4-2(Contact)	V <sub>ESD2</sub>	±15kV	kV
Operating Temperature Range	Topr	-55 ~ +125	°C
Storage Temperature Range	Tstg	-55 ~ +150	°C







#### **Circuit Diagram**

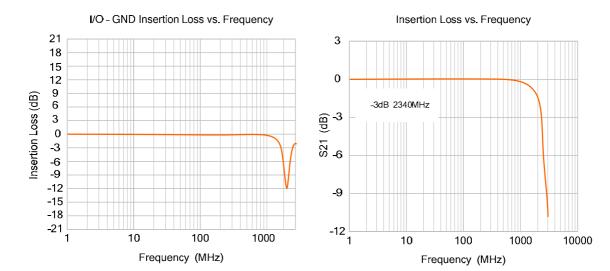




#### ELECTRICAL CHARACTERISTICS(Tamb=25°C)

Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Reverse Working	N	Any I/O pin to GND			Б	V
Voltage	V <sub>RWM</sub>				5	v
Reverse Breakdown	V	<sub>t</sub> =1mA;	6			V
Voltage	$V_{BR}$	Any I/O pin to GND	6			V
Reverse Leakage		V <sub>RWM</sub> =5V, T=25°C;		Typ.         Max.         Unit           5         V           1         ν           1         μA           13.0         V           1.8         V           0.3         0.4           0.6         0.8		
Current	I <sub>R</sub>	Any I/O pin to GND			1	μΑ
Depitive Clamping		I <sub>PP</sub> =1A, t <sub>P</sub> =8/20µs;			13.0	V
Positive Clamping	V <sub>C1</sub>	Positive pulse;				
Voltage		Any I/O pin to GND				
Negative Clamping		I <sub>PP</sub> =1A, t <sub>P</sub> =8/20μs;				
Negative Clamping	V <sub>C2</sub>	Negative pulse;		1.8		V
Voltage		Any I/O pin to GND				
Junction Capacitance	C <sub>J1</sub>	V <sub>R</sub> =0V, f=1MHz;		0.2	0.4	pF
Between Channel		Between I/O pins		0.3		
Junction Capacitance	C	V <sub>R</sub> =0V, f=1MHz;		0.6	0.9	nΕ
Between I/O And GND	C <sub>J2</sub>	Any I/O pin to GND		0.6	0.0	μr

#### TYPICAL ELECTRICAL CHARACTERISTICS CURVE





75

current

100

125

tr≕8µs td=20µs

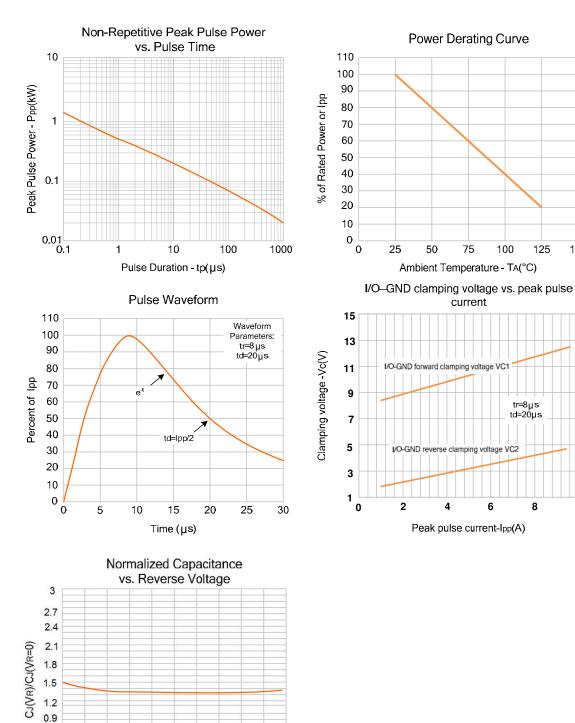
8

6

10

150

#### **TYPICAL ELECTRICAL CHARACTERISTICS CURVE**



F=1MHz

5

4

0.6 0.3

0

1

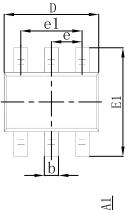
2

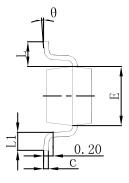
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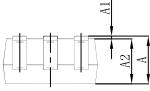
Reverse Voltage - VR(V)



### SOT-363 Package Outline Dimensions

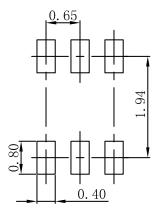






Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
Α	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
с	0.100	0.150	0.004	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.400	0.085	0.094
е	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

## SOT-363 Suggested Pad Layout



Note:

1.Controlling dimension:in millimeters.

2.General tolerance:±0.05mm.

3. The pad layout is for reference purposes only.



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